

C1206C562J5GAC7210

SMD Comm COG, Ceramic, 5600 pF, 5%, 50 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206



Click here for the 3D model.

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	1mm +/-0.10mm
В	0.5mm +/-0.25mm

Packaging Specifications		
Pa	ckaging	T&R, 330mm, Plastic Tape
Pa	ckaging Quantity	10000
Pa	ckaging Quantity	10000

General Information			
Series	SMD Comm COG		
Style	SMD Chip		
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I		
Features	Ultra-Stable, Low Loss, Class I		
RoHS	Yes		
Termination	Tin		
Marking	No		
AEC-Q200	No		
Component Weight	25 mg		
Shelf Life	78 Weeks		
MSL	1		

Specifications		
Capacitance	5600 pF	
Measurement Condition	1 kHz 1.0Vrms	
Capacitance Tolerance	5%	
Voltage DC	50 VDC	
Dielectric Withstanding Voltage	125 VDC	
Temperature Range	-55/+125°C	
Temperature Coefficient	COG	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms	
Dissipation Factor	0.1% 1 kHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour	
Insulation Resistance	100 GOhms	

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